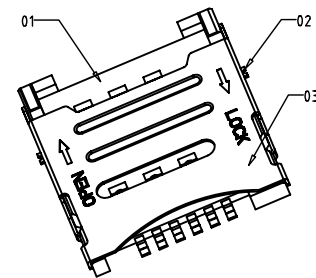


MICRO SIM



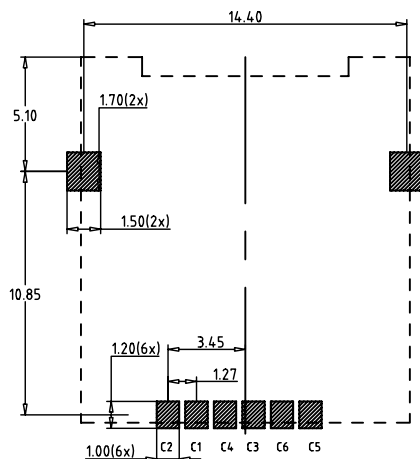
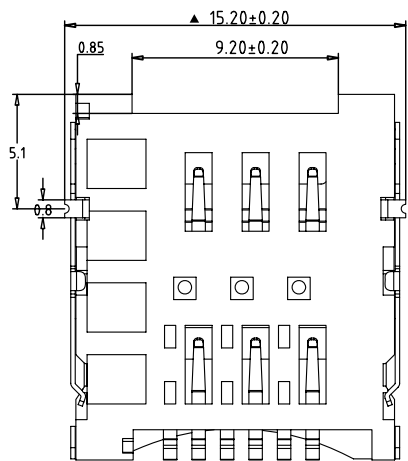
PIN NO.	NAME	PIN NO.	NAME
C1	VCC	C4	VPP
C2	GND	C5	CLK
C3	RST	C6	IO

一、材质和镀涂:

- 1、胶芯: LCP, UL 94 V - 0, 黑色
- 2、端子: 磷铜C5210-H, T=0.15, 镀底镀金
- 3、外壳: 不锈钢 SUS304 T=0.2

二、技术参数:

- 接触电阻: 100mΩ Max
- 绝缘阻抗: 1000MΩ Min(500DC)
- 额定电流: 每个接触件1A Max
- 额定电压: 30V Max(DC)
- 耐压: 500V r.m.s./min
- 使用温度: -40℃~85℃
- 湿度: 90%~95%
- 寿命: >3000次



PCB LAYOUT



深圳市华宇创精密电子有限公司

<b>TOLERANCE:</b> X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2' X.X' ±0.5'	<b>DRAWN BY :</b> 陈一鸣	<b>DATE :</b> 2014-02-23	<b>PART NAME:</b> MICRO SIM 6PIN 掀盖式1.8H
	<b>CHECKED BY:</b> 马跃	<b>DATE :</b> 2014-02-23	<b>PART NO.</b> HYC02-SIM06-180
<b>UNIT:</b> mm [inch]	<b>APPROVED BY:</b> 邱国夷	<b>DATE :</b> 2014-02-23	<b>DRAW NO:</b> HYC-SIM14081601
<b>SCALE:</b> 1:1 <b>SIZE:</b> A4			<b>SHEET NO.</b> 1 OF 1